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Quantum cascade lasers monolithically integrated on germanium.

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Abstract: Silicon (Si) photonics can have a major impact on the development of mid-IR photonics by leveraging on the reliable and high-volume fabrication technologies already developed for microelectronic integrated circuits. Germanium (Ge), already used in Si photonics, is a prime candidate to extend the operating wavelength of Group IV-based photonic integrated circuits beyond 8 μm , and potentially up to 15 μm . High performance quantum cascade lasers (QCLs) and interband cascade lasers grown on Si have been demonstrated, whereas no QCLs monolithically integrated on Ge have been reported yet. In this work, we present InAs-based QCLs directly grown on Ge by molecular beam epitaxy. The lasers emitting near 14 μm exhibited threshold current densities as low as 0.8-0.85 kA/cm^2 at room temperature.

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1. Introduction

Mid-infrared (mid-IR) integrated photonics is expected to provide key advances for the demonstration of systems on chip. The main foreseen applications are free space optical communications and mid-IR spectroscopy sensing with portable and cost-effective systems. Different solutions are currently explored for the development of integrated mid-IR platforms, based on chalcogenide glasses thanks to their wide mid-IR transparency window [1], or III-V materials with direct integration of quantum cascade lasers (QCLs) [2] or interband cascade lasers [3]. Silicon (Si) photonics can have a major impact on the development of mid-IR photonics by leveraging the reliable and high-volume fabrication technologies already developed for microelectronic integrated circuits [4]. Interestingly, germanium (Ge), already used in Si photonics, is a prime candidate to extend the operating wavelength of Group IV-based photonic integrated circuits beyond 8 μm , and potentially up to 15 μm [5]. Furthermore, Ge benefits from a strong third-order nonlinearity which can also be advantageously exploited for the development of active devices [6]. In recent years, the development of a photonic platform based on Ge or Ge-rich SiGe alloys and dedicated to long mid-IR wavelengths has witnessed a burst of research activity [7], which encourages the integration of new devices, especially laser sources. Quantum dot lasers emitting at 1.3 μm grown on Ge have been reported [8]. In this work, we present long-wavelength InAs-based QCLs directly grown on Ge by molecular beam epitaxy (MBE).

2. QCL fabrication

Monolithic integration of III-V devices on Ge is concerned by the same problems as the direct growth of these materials on silicon. The device performances are strongly affected by the different crystal structures of the III-V compounds and group-IV semiconductors, which results

45 in the formation of anti-phase domains (APD) with opposite polarities within the III-V material
46 [9]. The boundaries between these domains with inverted crystallographic orientation create
47 parasitic current channels that shorten the active region of the devices [9]. Another issue is the
48 large lattice mismatch between Ge and the materials used in mid-IR photonics which reaches
49 7% in the case of InAs- and GaSb-based structures. This mismatch is released through the
50 generation of dislocations that can thread through the heterostructure and degrade the photonic
51 devices grown on the mismatched substrate [8]. Our previous results showed however that
52 InAs/AlSb QCLs grown on Si were not largely concerned by the above-mentioned problems.
53 Performances of the devices emitting at 11 [2] and 7.5 μm [10] were similar to those of their
54 counterparts grown on native InAs substrates. The first QCLs on Si were grown on substrates
55 with a 6° cut, which favored a growth mode that provided domination of one of the
56 crystallographic polarities [2]. The impact of the remaining threading dislocations was probably
57 partially compensated for in these devices by the decreased interface roughness provided by
58 the employed growth mechanism, resulting in a higher QCL gain. In the next work, an on-axis
59 (001) Si substrate was used for growth which was initiated by a specially developed procedure
60 aimed at annihilation of APDs in a buffer layer, preventing their penetration into the QCL active
61 zone [10]. The density of the threading dislocations in these wafers grown on Si reached 10^8
62 cm^{-2} but the high performance of the fabricated lasers evidenced that the impact of dislocation-
63 related defects on the device operation was quite weak. This finding is primarily due to the very
64 short lifetimes of intersubband transitions, which makes them less sensitive to parasitic
65 recombination channels compared with most of interband emitters. Also, the chemical
66 composition of multicomponent III-V alloys grown on Si can be modified by mechanical strains
67 in vicinity of the dislocations, affecting the band structure and consequently the operation of
68 the concerned devices, such as GaInAs/AlInAs/InP QCLs [11]. In InAs/AlSb QCLs, the effect
69 of this mechanism is negligible. Thus, the main problem in fabricating InAs-based QCLs on
70 Ge is to provide an APD-free surface during the initial growth stage. The procedure employed
71 for the growth on Si cannot be directly transferred to the growth on Ge because of the different
72 chemical nature of these materials.

73 In this work, the QCL structures were grown by solid-source MBE on a (001) n-Ge substrate
74 with a residual miscut of $\sim 0.5^\circ$. Prior to the QCL growth, a template consisting of a 1.5- μm -
75 thick nominally undoped p-GaSb buffer layer capped by a 100-nm-thick, nominally undoped,
76 n-InAs layer was first grown using a specially developed procedure to promote burying of the

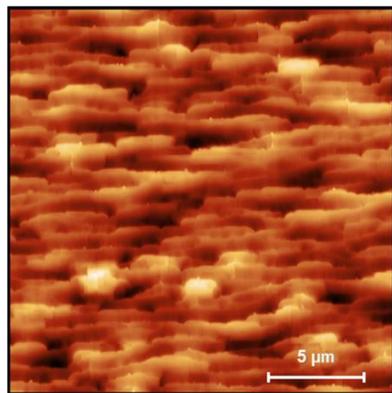


Fig.1. AFM image of the template.

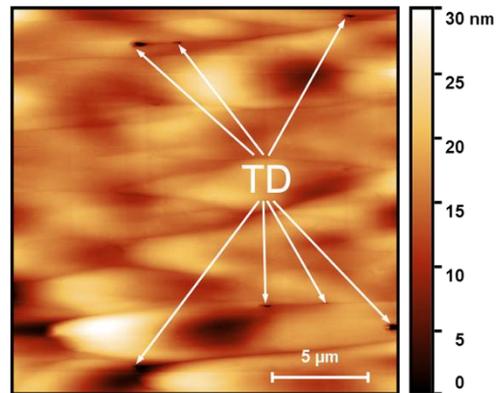


Fig.2. AFM image of the wafer EQ1092. A few threading dislocations (TD) are indicated.

77 APDs in the GaSb layer [12]. The template grown in a Riber C21 MBE system was then
78 transferred to a Riber R412 machine for the growth of the QCL structure EQ1092. The growth
79 in R412 was started by thermally desorbing the native oxide of the InAs layer at conditions
80 usually used to deoxidize InAs substrates. The InAs and AlSb layers were grown at deposition

81 rates of 3.03 and 1A/s, respectively, and a V/III flux ratio of ~ 2 . A reference QCL structure
 82 EQ1091 was previously grown on an InAs substrate. The active zone of the QCL consists of
 83 45 repetitions of the following layer sequence, in \AA and starting from the injection barrier:
 84 **26/41/1/62/1/67/2/66/2/64/6/64/6/62/6/59/9/58/10/57/11/56**, where AlSb layers are in bold and
 85 the Si-doped layers are underlined. The total electron sheet density N_s in the structure, taking
 86 into account the residual doping of InAs, is considered to be about $1 \times 10^{11} \text{ cm}^{-2}$ per period. The
 87 active zone is separated from 3- μm -thick InAs cladding layers doped with Si to $6 \times 10^{17} \text{ cm}^{-3}$ by
 88 3- μm -thick undoped InAs spacers. The images of the template surface obtained by atomic

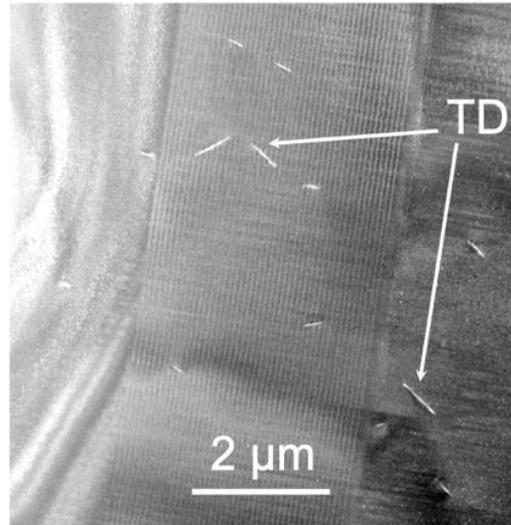


Fig.3. Cross-section TEM image of the QCL grown on Ge. Two threading dislocations (TD) are indicated.

89 force microscopy reveal the absence of APDs emerging at the template surface (Fig.1). The
 90 surface exhibit terraces with edges perpendicular to the direction of the substrate miscut. The
 91 rms roughness is 3.5 nm. After QCL growth, the surface is slightly undulated, with a rms
 92 roughness of 3.8 nm (Fig.2), a much better value than what we previously achieved on Si
 93 substrates [10]. The absence of APDs reaching the active zone has been confirmed by
 94 transmission electron microscopy (Fig. 3). In contrast, threading dislocations are clearly seen
 95 in both AFM and TEM images of the EQ1092 wafer (Fig.2 and 3, respectively). From this and
 96 other images, the density of dislocations threading the active zone is estimated to be in the low
 97 10^7 cm^{-2} . Such a density, however, is at the limit of TEM resolution and we can only give a
 98 rough – albeit informative – estimate. As expected from the different lattice mismatch, this
 99 value is much lower than the $\sim 10^8 \text{ cm}^{-2}$ value obtained for QCLs grown on Si [10].

100 The overlap of the fundamental mode with the active region, Γ , and the waveguide loss for an
 101 empty waveguide, α_w , were calculated to be 0.5 and 3.6 cm^{-1} , respectively. The waveguide loss
 102 associated with light absorption by free carriers in the doped cladding layers was computed
 103 using the Drude model with experimental material parameters [13], no absorption in the QCL
 104 active zone was taken into account. The wafer was processed into (16-20)- μm -wide ridges and
 105 deep mesa devices using standard optical photolithography and wet chemical etching. The
 106 substrate was then thinned down to 150 μm and cleaved into (1-3.6)-mm-long bars that were
 107 soldered with In onto copper heatsinks epi-side up. The devices were contacted to the
 108 metallized back side of the substrate and to the top of the n+-InAs cladding layer. The QCLs
 109 were tested in pulsed mode (333 ns/12 kHz) on the bars in a temperature stabilized probe station
 110 at 300K or in a flow LN₂ cryostat using wire bonding of selected devices. In both
 111 configurations, emission spectra were recorded with a Bruker V70 infrared Fourier transform

112 spectrometer (FTIR) equipped with a pyroelectric detector. An additional 30 Hz current
 113 modulation was applied for pulsed measurements of light-current curves with the slow FTIR
 114 detector. The reference lasers were fabricated and tested in the same way.

115 3. Results and discussion

116 Figure 4 displays the voltage-current (V-I) and light-current characteristics of 3.6-mm-long
 117 QCLs grown on Ge (EQ1092) in comparison with reference devices grown on a native InAs
 118 substrate (EQ1091). The QCLs grown on Ge exhibit threshold current densities J_{th} of 0.8-0.85
 119 kA/cm² in pulsed mode at room temperature (RT) compared to 0.71-0.73 kA/cm² for the
 120 reference devices of the same length. It is worth noting only a small additional voltage drop in
 121 the V-I characteristics introduced by the use of a Ge substrate, which indicates a good quality
 122 of electrical contacts and low resistance of the interface region between the QCL structure and
 123 the substrate. The large density of in-plane misfit dislocations is known to create a carrier
 124 density as high as 10²⁰ cm⁻³ in GaSb [14] that renders the GaSb/Ge interface highly conductive.
 125 Due to the specific type-III band alignment the p-GaSb/n-InAs heterojunction behaves as an
 126 ohmic contact [15].

127 The initial slope efficiency of these lasers is 110-120 and 120-135 mW/A, for EQ1092 and
 128 EQ1091 QCLs, respectively, with an optical power reaching 80 mW for the best

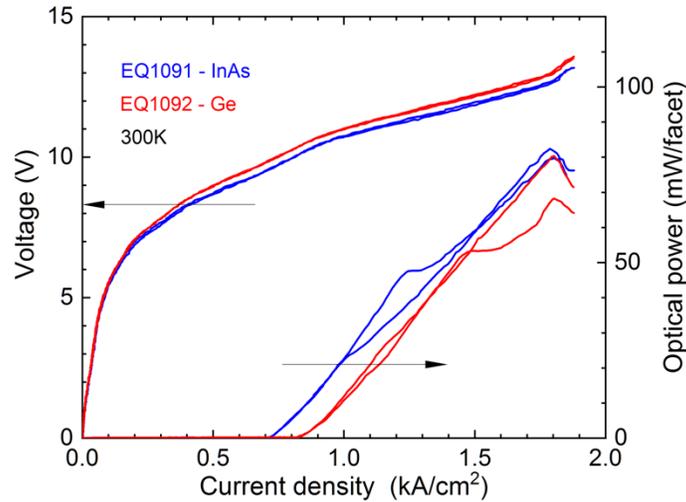


Fig.4. Voltage-current (left scale) and light-current (right scale) characteristics of two 3.6-mm-long lasers from both studied wafers. The ridge width is 18 and 19 μm for the lasers EQ1091 and EQ1092, respectively.

129 devices. The temperature dependence of the threshold current is very similar for the devices
 130 fabricated from both studied wafers (Fig.5) with a characteristic temperature T_0 of this
 131 exponential dependence close to 160 K. Emission spectra of the QCL presented in the insets in
 132 Fig.5 are centered at 13.8-14.0 μm , slightly below 14.2 μm expected from the simulations.

133 Figure 6 shows the threshold current densities of the studied QCLs fabricated from both wafers
 134 plotted as a function of reciprocal cavity length. This data can be analyzed using the general
 135 QCL threshold condition [16]:

$$136 \quad J_{th} = J_{tr} + \frac{(\alpha_w + \alpha_m)}{\Gamma g} = J_{tr} + \frac{\alpha_w}{\Gamma g} - \frac{\ln(R)}{\Gamma g} \frac{1}{L}$$

137 where J_{tr} is the transparency current, α_m is the mirror loss depending on the laser length L , $R =$
 138 0.29 the facet reflectivity calculated using the Fresnel formula for the given dielectric
 139 waveguide and g is the differential gain.

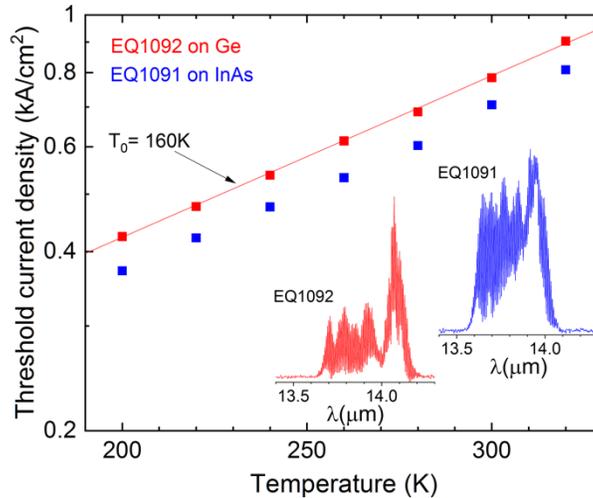


Fig.5. Threshold current density of the 3.6-mm-long QCLs as a function of temperature. The insets show RT emission spectra measured at RT at about 1.5 kA/cm².

140 The linear fits of the data in Fig.6 are parallel for both QCLs grown on Ge and the reference
 141 devices and indicate the same differential gain of 22 cm/kA that corresponds to the material
 142 gain of 44 cm/kA considering the overlap of the optical mode with the gain region. The
 143 threshold current densities of the lasers grown on Ge are higher by about 15% compared with
 144 the devices grown on the native substrate. It is interesting to note that this difference is nearly
 145 constant for devices of different lengths and does not change with temperature (Fig.4).

146 As can be seen from the data shown in Fig.6, the transparency current is the main component
 147 of the threshold in the reference QCLs, whereas the waveguide loss $\alpha_w = 3.6 \text{ cm}^{-1}$ is responsible
 148 for about 25% of the threshold current in long lasers. The transparency current includes a
 149 current associated with electrons bypassing the lasing transition in the QCL active region and
 150 also the current leakage over the ridge edges related to the device fabrication. However, the
 151 principal element of the transparency current is the thermal backfilling of the lower laser
 152 transition level, which requires an additional current J_{bf} to be injected to compensate the
 153 resulting decrease in the population inversion [17]. The impact of thermal backfilling on device
 154 performance is governed by the QCL design, namely, by the width of the injector miniband
 155 Δ_{inj} , and the doping level N_s . Comparison of the low-bias parts of the very similar voltage-
 156 current characteristics presented in Fig.4 clearly shows that there is no current related to
 157 additional leakage of any origin in the QCLs grown on Ge. The small extra voltage at higher
 158 currents can be, in principle, explained by a larger Δ_{inj} , and/or lower N_s in the EQ1092 lasers.
 159 However, both factors should reduce the thermal backfilling and thus J_{tr} , which is evidently not
 160 the case. It is more reasonable to attribute the observed shift of the data for the EQ1092 lasers
 161 to an additional loss $\alpha_d = 2.6 \text{ cm}^{-1}$ in the laser waveguide (Fig.6), which, in turn, can be due to
 162 the light scattering on defects related to threading dislocations (Figs.2,3). This conclusion
 163 agrees with previously reported results on InAs-based QCLs grown on an on-axis silicon
 164 substrate [10]. Those lasers had threshold current densities 22% higher than the devices grown
 165 on the native substrate. This difference did not change much with temperature demonstrating

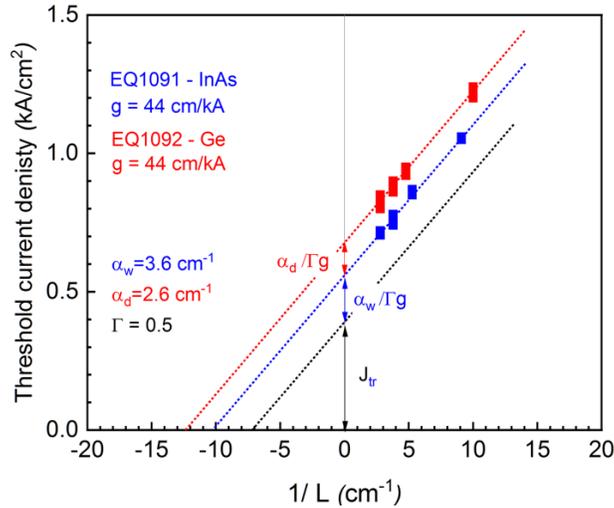


Fig.6. Threshold current density of the studied QCLs as a function of the reciprocal cavity length. At least five devices were measured at each length for both wafers.

166 the same T_0 value around room temperature. The observed increase in J_{th} was explained by
 167 higher optical losses because of additional absorption on crystal imperfections. In this work,
 168 we succeeded to quantify this effect by careful characterizations of lasers of different length.
 169 The weaker J_{th} degradation of 15% reflects a lower density of threading dislocations originating
 170 from the smaller lattice mismatch between the QCL material and the Ge substrate and is
 171 confirmed by the TEM observations.

172 One can compare these results with those of mature InP QCLs that exhibit low threshold current
 173 densities when grown on their native substrate [18] but higher densities when grown on silicon
 174 [19]. Interestingly, their properties degrade drastically as well even when heterogeneously
 175 integrated onto Si- or Ge-based platforms. Notably, their threshold current density increases in
 176 the 1.5 – 3 kA/cm² range, and their maximum operating temperature decreases down to 30 –
 177 60 °C [20-22]. This is in marked contrast to the results reported here and in previous
 178 publications that show similar performance for InAs/AlSb QCLs epitaxied on their native InAs
 179 substrate, on Ge (this work), or on Si substrates [10].

180 4. Conclusions

181 In conclusion, we demonstrated InAs-based QCLs operating near 14 μm with a pulsed
 182 threshold current density as low as 0.8-0.85 kA/cm² in 3.6-mm-long lasers at room temperature.
 183 This value is just 15 % higher than that of the reference devices grown on a native InAs
 184 substrate. We attribute this increase in threshold current density to an additional optical loss α_d
 185 = 2.6 cm⁻¹ in the laser waveguide due to light scattering on threading misfit dislocations. The
 186 high performance of the studied QCLs confirm their suitability for monolithic integration on
 187 Si/Ge mid-IR photonic circuits.

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191 **Disclosures.** The authors declare no conflict of interest.

192 **Data availability.** Data underlying the results presented in this article are not publicly
 193 available at this time, but may be obtained from the authors upon reasonable request.

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